

145 Royal Crest Court Unit 42 Markham, ON, Canada L3R 9Z4 Tel: 905-477-1166 Fax: 905-477-1782 http://www.orientdisplay.com

SPECIFICATION FOR LCM MODULE

MODULE NO.: AFA320240C256-3.5-A03 DOC. REVISION00

Customer Approval:

	SIGNATURE	DATE
PREPARED BY (RD ENGINEER)		
PREPARED BY (QA ENGINEER)		
CHECKED BY		
APPROVED BY		

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CONTENTS

1. Functions & Features	2
2. M echanical specifications	2
3. Block diagram	2
4. Dimensional Outline	3
5. Pin description	4
5. Maximum absolute limit	4
7. E lectrical characteristics	5
B. Backlight Characteristics	5
9. E lectro-Optical characteristics	5
10. Timing Characteristics	6-7
11. Control and Display Instruction	7-10
12. Quality Specifications	10-18

1. Functions & Features

1.1. Format : 320x240 Dots 1.2. LCD mode : Transmissive 1.3. Viewing direction : 6 O'clock 1.4. Display color : 256 colors 1.5. Operation temp :-20~70 ℃ 1.6. Storage temp :-30~80℃ 1.7. Power supply voltage (V_{DD}) : 3.3V 1.8. LED power voltage : 3.3V 1.9. Backlight color : White(LED) 1.10 LCM Contrast ratio : 300:1 1.11 LCM Birghtness : 200 nit(tye)

1.12.RoHS standard

2. MECHANICAL SPECIFICATIONS

2.1. Module size : 92.0mm(L)*78.4mm(W)*10.5(Max) mm (H)

2.2. Viewing area : 73.3mm(L)*55.8mm(W) 2.3. Pixel size : 73.0um(W)*219.0um(H)

2.4. Weight : Approx.

3. BLOCK DIAGRAM

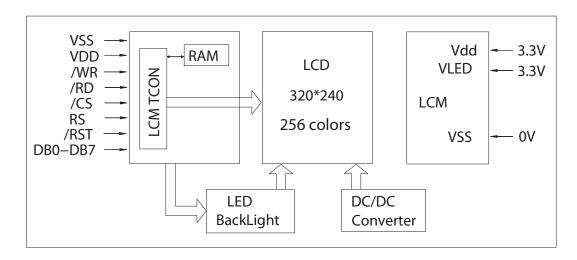


Figure 1. Block diagram

4. DIMENSIONAL OUTLINE

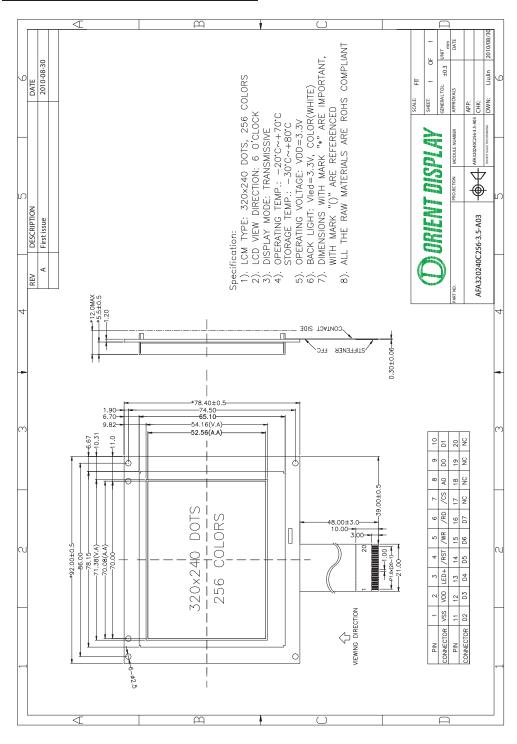


Figure 2. Dimensional outline

5. PIN DESCRIPTION

No.	Symbol	Function
1	VSS	GND
2	VDD	Logic supply voltage (3.3V)
3	LED+	Power supply for backlight(+3.\mathbf{y})
4	/RST	Reset signal (L)
5	/WR	Write signal
6	/RD	Read signal
7	/CS	Chip enable signal
8	A0	Register selection (H:Data register, L:Instruction register)
9~16	D0~D7	Data bus line
17	NC	
18	NC	
19	NC	
20	NC	

6. MAXIMUM ABSOUTE LIMIT

ltem	Symbol	MIN	MAX	Unit
Supply Voltage for Logic	V DD	-0.3	5.0	V
Input V oltage	Vin	-0.3	V DD+0.3	V
Supply Current	$I_{DD}(Ta = 25^{\circ}C)$		75	mA
(Without Backllight)				
Supply Current for Backlight	I _F (Ta = 25°C)		130	mA
Reverse Voltage for Backlight	V r(Ta = 25°C)		5.5	V
Operating Temperature	Тор	-20	70	$^{\circ}\mathbb{C}$
Storage Temperature	Tst	-30	80	$^{\circ}\mathbb{C}$

7. ELECTRICAL CHARACTERISTICS

Item	Symbol	Condition	Min	Тур	Max	Unit
Supply Voltage for Logic	V DD-V SS	Ta = 25°C	3.0	3.3	3.6	V
Input High Voltage	ViH	Ta = 25°C	08V DD		V DD	V
Input Low Voltage	VıL	Ta = 25°C	0		02V DD	V
Output High Voltage	Vон	Ta = 25°C	08V DD		V dd	V
Output Low Voltage	Vol		0		02V DD	V
Supply Current	IDD	Ta = 25°C		65	75	mA
(Without Backllight)						

8. BACKLIGHT CHARACTERISTICS

Ta = 25°C

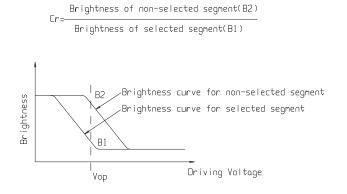
Item	Symbol	Condition	Min	Тур	Max	Unit
Forward Voltage	VF	Vled=3.3V	3.0	3.3	5.0	V
Forward Current	IR	Vled=3.3V	88	120	128	mA
Luminous Intensity (With LCD dots off)	IV	Vled=3.3V	150	200		Cd/m ²
LED Backlight Color	White					

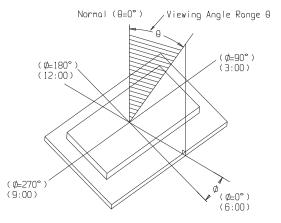
ltem	Symbol	Condition	Min	Тур	Max	Unit
		Ta = 25°C				
		Humidity:				
LED Life time		70% below		50,000		Hr
		Forward Current:				
		20mA				

9. ELECTRO-OPTICAL CHARACTERISTICS

 $(VDD=3.3V,Vled=5.0V,Ta=25^{\circ}C)$

Item	Symbol	Condition	Min	Тур	Max	Unit	
	θL	=180°(9 o'clock)	45	60			
Viewing angle	θr	=0°(3 o'clock)	45	60			
(CR≥10)	θτ	=90°(12 o'clock)	35	50		degree	
	θв	=270°(6 o'clock)	40	55			
Response time	Ton			10	20	ms	
nesponse time	Toff	Normal		15	25	ms	
Contrast ratio	Cr	θ= =0°	150	300			
Luminance	L1		150	200		Cd/m2	





10. TIMING CHARACTERISTICS

10.1 Interface Timing

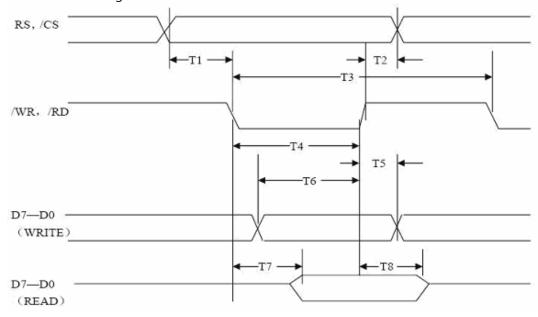


Figure 4. 8080 family Interface Timing

10.2 MCU Interface

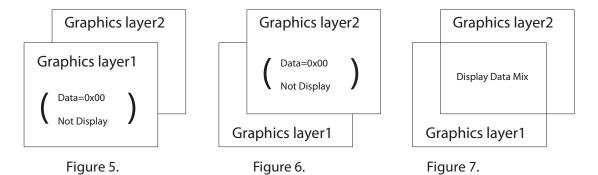
Signal	Symbol	Parameter	VDD	=33V	Unit	Condition
J.g.i.a.	3,	T didiffece.	Min	Max	01110	Condition
RS,/CS	T2	Address hold time	10	-	ns	
113,7 23	T1 Address setup time		0	-	ns	
/WR,/RD	T3	System cycle time	350	-	ns	
, , , , , , ,	T4	Strobe pulsewidth	180	-	ns	CL=100p
	T5	Data hold time	80	-	ns	F
D0-D7	T6	T6 Data setup time		-	ns	
	T7	/RD Access time	-	50	ns	
	T8	Output disable time	10	50	ns	

11. CONTROL AND DISPLAY INSTRUCTION

11.1 Instruction

Command	Со	mmand Code	Function		
(Hex)	/CS RS /WR /RD	D7 D6 D5 D4 D3 D2 D1 D0			
0x80	0 0 0 1 1	0 0 0 0 0 0	Display on glayer1		
			Read and Write on glayer1		
0x81	0 0 0 1 1	0 0 0 0 0 0 1	Display and Read on glayer1		
			Write on glayer2		
0x82	0 0 0 1	10000010	Display and Write on glayer1		
			Read on glayer2		
0x83	0 0 0 1 1	0 0 0 0 0 1 1	Display on glayer1		
			Write and Read on glayer2		
0x84	0 0 0 1 1	0 0 0 0 1 0 0	Display on glayer2		
			Read and Write on glayer1		
0x85	0 0 0 1 1	0 0 0 0 1 0 1	Display and Write on glayer2		
			Read on glayer1		
0x86	0 0 0 1 1	0 0 0 0 1 1 0	Display and Read on glayer2		
			Write on glayer1		
0x87	0 0 0 1 1	0 0 0 0 1 1 1	Display on glayer2		
			Write and Read on glayer2		
0x90	0 0 0 1	10010000	Black light off		
0x91	0 0 0 1	10010001	Black light on		
0xa0	0 0 0 1 1	0 1 0 0 0 0 0	Mix Mode off (Single layer display)		
0xa1	0 0 0 1 1	0 1 0 0 0 0 1	Mix Mode 1 (Front: glay1, Rear: glay2)		
			(Figure 5.)		
0xa2	0 0 0 1 1	0 1 0 0 0 1 0	Mix Mode 2 (Front: glay2, Rear: glay1) (Figure 6.)		
0xa3	0 0 0 1 1	0 1 0 0 0 1 1	Mix Mode 3 (Mix glay1 and glay2)		
			(Figure 7.)		
0xfc	0 0 0 1	1 1 1 1 1 0 0	display on		
0xfd	0 0 0 1	1 1 1 1 1 0 1	display off		
Address	0 0 0 1	0000000	Write X Adderss(H)		
set	0 0 0 1		Write X Adderss(L)		
X(0~320)	0 0 0 1		Write Y Adderss		
Y(0~240)					
Write data	0 1 0 1		Write display data		
Read data	0 1 1 0		Read display data		

Note: Continuum write display data, Address is increased by 1 automatically.



11.2 Display Data format(256 Colors)

DB7	DB6	DB5	DB4	D	B3	DB2	D)B1	DB0	
R2	R1	R)	G2	G1		G0	B1	В0	
MSB	MSB LSB		MSB	LSB		MSB	LSB			
RED (000~111)			GREEN(000~111)			BLUE	(00~11)			

D7, D6,D5,D4,D3,D2,D1,D0 (0xXX)	DOT	
1 1 1 1 1 1 1 (0xFF)	White	
0 0 0 0 0 0 0 0 (0x00)	Back	
1 1 1 0 0 0 0 0 (0xE0)	Red	
0 0 0 1 1 1 0 0 (0x1C)	Green	
0 0 0 0 0 0 1 1 (0x03)	Blue	
1 1 1 1 1 0 0 (0xFC)	Yellow	
1 1 1 0 0 0 1 1 (0xE3)	Purple	
0 0 0 1 1 1 1 1 (0x1F)	Cyan	

11.3 Porgram Example

```
// VDD=3.3V
#include <reg51.h>
#define uint unsigned int
#define uchar unsigned char
sbit CS
        = P 3^2;
sbit RS = P 3^3;
sbit WRR = P3^4;
sbit RDD = P3^5;
sbit RST = P3^6;
void wcomd(uchar ch)
  RDD=1;RS=0; CS=0;
  P1=ch;
  WRR=0;
  WRR=1;
  CS=1;
}
void wdata(uchar ch)
```

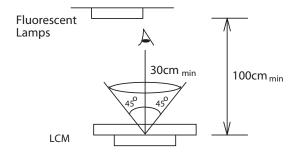
```
RDD=1;RS=1; CS=0;
  P1=ch;
 WRR=0;
  WRR=1;
  CS=1;
unsigned char rdata(void)
  uchar ch;
  WRR=1;RS=1; CS=0;
  P1=0xff;
  RDD=0;
  ch=P1;
  RDD=1;
  CS=1;
  return(ch);
void waddr(uint xdat,uint ydat)
 uint xxh,xxl;
  xxh=xdat/256;
  xxl=xdat%256;
  wcomd(xxh);
 wcomd(xxl);
  wcomd(ydat);
void initial_tft()
                            //led light on
  wcomd(0x91);
  wcomd(0xfc);
                            //display on
  wcomd(0xa0);
                            //mix mode off
void disp_all(uchar xsdata)
  uint j,k;
  waddr(0x00,0x00);
  for(k=0;k<240;k++)
    for(j=0;j<320;j++)
    { wdata(xsdata);}
 }
}
void main(void)
  RST=0;delay(50);RST=1;delay(20);
  initial_tft();
  while(1)
```

12.QUALITY SPECIFICATIONS

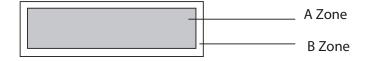
12.1 Standard of the product appearance test

Manner of appearance test: Thenspection should be performed in using 20W x 2 fluorescent lamps. Distance between LCM and fluorescent lamps should be 100 cm or more. Distance between LCM and inspector eyes should be 30 cm or more.

Viewing direction for inspection is 45° from vertical against LCM.



Definition of zone:



A Zone: Active display area (minimum viewing area). B Zone: Non-active display area (outside viewing area).

12.2 Specification of quality assurance AQL inspection standard

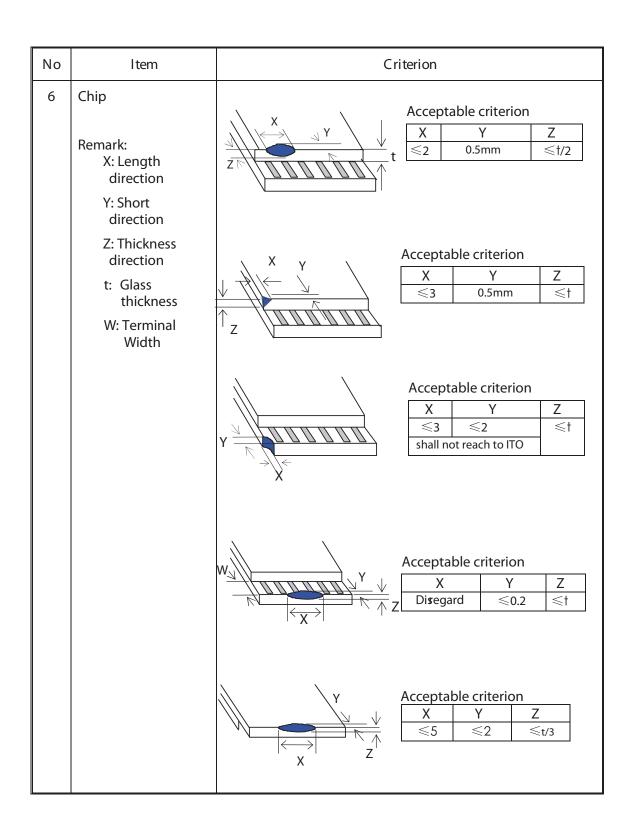
Sampling method: MIL-STD-105E, Level II, single sampling

Defect classification (Note: * is not including)

Classify		Item	Note	AQL
Major	Display state	Short or open circuit	1	0.65
		LC leakage		
		Flickering		
		No display		
		Wrong viewing direction		
		Contrast defect (dim, ghost)	2	
		B ack-light	1,8	
	Non-display	Flat cable or pin reverse	10	
		Wrong or missing component	11	
Minor	Display	Background color deviation	2	1.0
	state	B lack spot and dust	3	
		Line defect, Scratch	4	
		Rainbow	5	
		Chip	6	
		Pin hole	7	
		Protruded	12	
	Polarizer	Bubble and foreign material	3	
	Soldering	Poor connection	9	
	Wire	Poor connection	10]
	TAB	Position, Bonding strength	13	

Note on defect classification

No.	Item	Criterion				
1	Short or open circuit	Not allow				
	LC leakage					
	Flickering					
	No display					
	Wrong viewing direction					
	Wrong Back-light					
2	Contrast defect	Refer to approval sample				
	Background color deviation					
3	Point defect, Black spot, dust (including Polarizer) $\phi = (X+Y)/2$	Q Q Y X		0	Point Size φ≤0.10 .10<φ≤0.20 .20<φ≤0.25 .25<φ≤0.30	Acceptable Qty. Disregard 3 2 1
			Un		φ>0.30 mm	0
4	Line defect,	↓ w	Line Acceptable Q			
	Scratch				Line W	Acceptable Qty.
		L			0.015≥W	Disregard
			5.0 ≥ 5.0 ≥		0.03 ≥W 0.05 ≥W	2
			5.0 ≥		0.03 > W	1
					0.05 <w< td=""><td>Applied as point defect</td></w<>	Applied as point defect
		Unit: mm				
5	Rainbow	Not more than two color changes across the viewing area.				



No.	ltem	Criterion			
7	Segment pattern $W = \text{Segment width}$ $\phi = (X+Y)/2$	(1) Pin hole $ \phi < 0.10 \text{mm is acceptable.} $ $ X \longrightarrow // $			
		Point Size Acceptable Qty			
		Unit: m m			
8	Back-light	(1) The color of backlight should correspond its specification.			
9	Soldering	(2) Not allow flickering (1) Not allow heavy dirty and solder ball on PCB. (The size of dirty refer to point and dust defect) (2) Over 50% of lead should be soldered on Land. Lead Land 50% lead			
10	Wire	 (1) Copper wire should not be rusted (2) Not allow crack on copper wire connection. (3) Not allow reversing the position of the flat cable. (4) Not allow exposed copper wire inside the flat cable. 			
11*	РСВ	(1) Not allow screw rust or damage.(2) Not allow missing or wrong putting of component.			

No	Item	Criterion		
12	Protruded W: Terminal Width	Acceptable criteria: $Y \le 0.4$		
13	ТАВ	1. Position $\begin{array}{cccccccccccccccccccccccccccccccccccc$		
		P (=F/TAB bonding width) ≥650gf/cm ,(speed rate: 1mm/min) 5pcs per SOA (shipment)		
14	Total no. of acceptable Defect	A. Zone Maximum 2 minor non-conformities per one unit. Defect distance: each point to be separated over 10mm B. Zone It is acceptable when it is no trouble for quality and assembly in customer's end product.		

12.3 Reliability of LCM Reliability test condition:

Item	Condition	Time (hrs)	A ssessment	
High temp. Storage	80°C	48		
High temp. Operating	70°C	48		
Low temp. Storage	-30°C	48	No abnormalities	
Low temp. Operating	-20°C	48	in functions	
Humidity	40°C/ 90%RH	48	and appearance	
Temp. Cycle	-20°C ← 25°C → 70°C	10cycles		
	(30 min ← 5 min → 30min)			

Recovery time should be 24 hours minimum. Morever, functions, performance and appearance ,etc. shall be free from remarkable deterioration within 50,000 hours under ordinary operating and storage conditions room temperature ($20\pm8^{\circ}$ C), normal humidity (below $45\pm20\%$ RH), and in the area not exposed to direct sun light. The life time is not content the life time of the LED (for the life time of LED which decay only 50%,in the industry the experience value is 50000 hours, but there are not any experimentation data to support this).

12.4 Precaution for using LCD/LCM

LCD/LCM is assembled and adjusted with a high degree of precision. Do not attempt to make any alteration or modification. The followings should be noted.

General Precautions:

- 1. LCD panel is made of glass. Avoid excessive mechanical shock or applying strong pressure onto the surface of display area.
- 2. The polarizer used on the display surface is easily scratched and damaged. Extreme care should be taken when handling. To clean dust or dirt off the display surface, wipe gently with cotton, or other soft material soaked with isoproply alcohol, ethyl alcohol or trichlorotriflorothane, do not use water, ketone or aromatics and never scrub hard.
- 3. Do not tamper in any way with the tabs on the metal frame.
- 4. Do not make any modification on the PCB without consulting Orient Display.
- 5. When mounting a LCM, make sure that the PCB is not under any stress such as bending or twisting. Elastomer contacts are very delicate and missing pixels could result from slight dislocation of any of the elements.

- 6. Avoid pressing on the metal bezel, otherwise the elastomer connector could be deformed and lose contact, resulting in missing pixelsand also cause rainbow on the display.
- 7. Be careful not to touch or swallow liquid crystal that might leak from a damaged cell. Any liquid crystal adheres to skin or clothes, wash it off immediately with soap and water.

Static Electricity Precautions:

- 1. CMOS-LSI is used for the module circuit; ther efore operators should be grounded whenever he/she comes into contact with the module.
- 2. Do not touch any of the conductive parts such as the LSI pads; the copper leads on the PCB and the interface terminals with any parts of the human body.
- 3. Do not touch the connection terminals of the display with bare hand; it will cause disconnection or defective insulation of terminals.
- 4. The modules should be kept in anti-static bags or other containers resistant to static for storage.
- 5. Only properly grounded soldering irons should be used.
- 6. If an electric screwdriver is used, it should be grounded and shielded to prevent sparks.
- 7. The normal static prevention measures should be observed for work clothes and working benches.
- 8. Since dry air is inductive to static, a relative humidity of 50-60% is recommended.

Soldering Precautions:

- 1. Soldering should be performed only on the I/O terminals.
- 2. Use soldering irons with proper grounding and no leakage.
- 3. Soldering temperature: 280°C+10°C
- 4. Soldering time: 3 to 4 second.
- 5. Use eutectic solder with resin flux filling.
- 6. If flux is used, the LCD surface should be protected to avoid spattering flux.
- 7. Flux residue should be removed.

Operation Precautions:

- 1. The viewing angle can be adjusted by varying the LCD driving voltage Vo.
- 2. Since applied DC voltage causes electro-chemical eactions, which deteriorate the display, the applied pulse waveform should be a symmetric waveform such that no DC component remains. Be sure to use the specified operating voltage.
- 3. Driving voltage should be kept within specified range; excess voltage will shorten display life.
- 4. Response time increases with decrease in temperature.
- 5. Display color may be affected at temperatures above its operational range.
- 6. Keep the temperature within the specified range usage and storage. Excessive temperature and humidity could cause polarization degradation, polarizer peel-off or generate bubbles.
- 7. For long-term storage over 40°C is required, the relative humidity should be kept below 60%, and avoid direct sunlight.

Limited Warranty

Orient Display LCDs and modules are not consumer products, but may be incorporated by OD's customers into consumer products or components thereof, Orient Display does not warrant that its LCDs and components are fit for any such particular purpose.

- 1. The liability of Orient Display is limted to repair or replacement on the terms set forth below. Orient Display will not be responsible for any subsequent or consequential events or injury or damage to any personnel or user including third party personnal and/or user. Unless otherwise agreed in writing between Orient Display and the customer, Orient Display will only replace or repair any of its LCD which is found defective electrically or visually when inspected in accordance with Orient Display general LCD inspection standard. (Copies available on request)
- 2. No warrenty can be granted if any of the precautions state in handling liquid crystal display above has been disregarded. Broken glass, scratches on polarizer mechanical damages as well as defects that are caused accelerated environment tests are excluded from warranty.
- 3. In returning the LCD/LCM, they must be properly packaged; there should be detailed description of the failures or defect.